



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Benfer, David W	<b>Contact Title</b>	Prod Compliance Engineer		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2017-07-21	<b>Contact Email</b>	dave.benfer@te.com				
<b>Contact Phone Number</b>	717-986-3725								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	2199337-5	<b>Amount</b>	210.0	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	ASS'Y FOR MICRO SIM H1.18 8POS (EMBOSS)	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUROHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0616</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Complex Article Description</b>	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Sub-Item	1	SHELL FOR MICRO-SIM H1.18 PUSH-PULL				1.0	125.0	mg	
Material	2	Stainless Steel				1.0	118.0	mg	
Substance	3	Chromium	Supplier	7440-47-3	18.0	1.0	21.24	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.5	1.0	0.59	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.045	1.0	0.0531	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.0118	mg	
Substance	3	Carbon	Supplier	7440-44-0	0.15	1.0	0.177	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.01	1.0	0.0118	mg	
Substance	3	Silicon	Supplier	7440-21-3	1.5	1.0	1.77	mg	
Substance	3	Manganese	Supplier	7439-96-5	2.0	1.0	2.36	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.03	1.0	0.0354	mg	
Substance	3	Sulfur	Supplier	7704-34-9	0.03	1.0	0.0354	mg	
Substance	3	Iron	Supplier	7439-89-6	68.6147	1.0	80.96535	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0999	1.0	0.11788	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0099	1.0	0.011682	mg	
Substance	3	Nickel	Nickel	7440-02-0	9.0	1.0	10.62	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	5.9E-4	mg	
Material	2	Nickel Plate				1.0	6.94	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.01388	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.00694	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	6.91918	mg	
Material	2	Tin Plate				1.0	0.06	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	1.2E-4	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	1.0	0.059838	mg	

Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.0	4.2E-5	mg	
Sub-Item	1	INSERT MOLD MICRO SIM PUSH-PULL 8POS				1.0	85.0	mg	
Material	2	Nickel Plate				1.0	2.11	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.00211	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00422	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	2.10367	mg	
Material	2	Gold Plate				1.0	0.05	mg	
Substance	3	Gold	Supplier	7440-57-5	99.0	1.0	0.0495	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	1.0	1.0	5.0E-4	mg	
Material	2	LCP-(MD+GF)30				1.0	43.0	mg	
Substance	3	Carbon black	Supplier	1333-86-4	1.0	1.0	0.43	mg	
Substance	3	Phenol	Supplier	108-95-2	0.0040	1.0	0.00172	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	10.0	1.0	4.3	mg	
Substance	3	1,4-Benzenedicarboxylic acid, polymer with [1,1-biphenyl]-4,4-diol, 4-hydroxybenzoic acid and 6-hydroxy-2-naphthalenecarboxylic acid, acetate, potassium salt	Supplier	132699-78-6	66.996	1.0	28.80828	mg	
Substance	3	Mica-group minerals	Supplier	12001-26-2	22.0	1.0	9.46	mg	
Material	2	Copper				1.0	39.84	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.01992	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	3.984E-4	mg	
Substance	3	Silicon	Supplier	7440-21-3	1.2	1.0	0.47808	mg	
Substance	3	Copper	Supplier	7440-50-8	94.1635	1.0	37.51474	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.003984	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.015	1.0	0.005976	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0050	1.0	0.001992	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	1.0	0.01992	mg	
Substance	3	Cobalt	Supplier	7440-48-4	2.0	1.0	0.7968	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	1.992E-4	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	1.0	0.001992	mg	
Substance	3	Nickel	Nickel	7440-02-0	2.5	1.0	0.996	mg	